SN74LVC821A 10-BIT BUS-INTERFACE FLIP-FLOP WITH 3-STATE OUTPUTS

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- Operates From 1.65 V to 3.6 V
- Inputs Accept Voltages to 5.5 V
- Max t_{pd} of 7.3 ns at 3.3 V
- Typical V_{OLP} (Output Ground Bounce)
 <0.8 V at V_{CC} = 3.3 V, T_A = 25°C
- Typical V_{OHV} (Output V_{OH} Undershoot)
 >2 V at V_{CC} = 3.3 V, T_A = 25°C
- Supports Mixed-Mode Signal Operation on All Ports (5-V Input/Output Voltage With 3.3-V V_{CC})
- I_{off} Supports Partial-Power-Down Mode Operation
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)

OE 1 24 V_{CC} 1D 2 23 1Q 2D 3 22 2Q 3D 4 21 3Q 4D 5 20 4Q 5D 6 19 5Q 6D 7 18 6Q

DB, DGV, DW, NS, OR PW PACKAGE

(TOP VIEW)

7D 8 17 7Q 8D 9 16 8Q 9D 10 15 9Q 10D 11 14 10Q GND 12 13 CLK

description/ordering information

This 10-bit bus-interface flip-flop is designed for 1.65-V to 3.6-V V_{CC} operation.

The SN74LVC821A features 3-state outputs designed specifically for driving highly capacitive or relatively low-impedance loads. This device is particularly suitable for implementing wider buffer registers, I/O ports, bidirectional bus drivers with parity, and working registers.

The ten flip-flops are edge-triggered D-type flip-flops. On the positive transition of the clock (CLK) input, the device provides true data at the Q outputs.

A buffered output-enable (\overline{OE}) input can be used to place the ten outputs in either a normal logic state (high or low logic levels) or the high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and increased drive provide the capability to drive bus lines without interface or pullup components.

OE does not affect the internal operations of the latch. Previously stored data can be retained or new data can be entered while the outputs are in the high-impedance state.

ORDERING INFORMATION

TA	PACK	AGE†	ORDERABLE PART NUMBER	TOP-SIDE MARKING
	COIC DW	Tube of 25	SN74LVC821ADW	11/00044
	SOIC - DW	Reel of 2000	SN74LVC821ADWR	LVC821A
	SOP – NS	Reel of 2000	SN74LVC821ANSR	LVC821A
-40°C to 85°C	SSOP – DB	Reel of 2000	SN74LVC821ADBR	LC821A
-40 C to 65 C		Tube of 60	SN74LVC821APW	
	TSSOP – PW	Reel of 2000	SN74LVC821APWR	LC821A
		Reel of 250	SN74LVC821APWT	
	TVSOP - DGV	Reel of 2000	SN74LVC821ADGVR	LC821A

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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description/ordering information (continued)

Inputs can be driven from either 3.3-V or 5-V devices. This feature allows the use of this device as a translator in a mixed 3.3-V/5-V system environment.

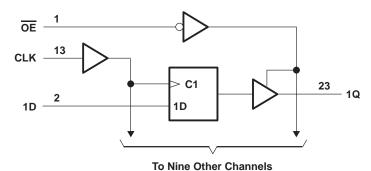
This device is fully specified for partial-power-down applications using I_{off} . The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

To ensure the high-impedance state during power up or power down, $\overline{\text{OE}}$ should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

FUNCTION TABLE (each flip-flop)

	INPUTS		OUTPUT
OE	CLK	D	Q
L	↑	Н	Н
L	\uparrow	L	L
L	H or L	Χ	Q_0
Н	Χ	Χ	Z

logic diagram (positive logic)





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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC}	
Voltage range applied to any output in the high-impedance or power-off state, V _O (see Note 1)	–0.5 V to 6.5 V
Voltage range applied to any output in the high or low state, V _O (see Notes 1 and 2)	–0.5 V to V _{CC} + 0.5 V
Input clamp current, I _{IK} (V _I < 0)	
Output clamp current, I_{OK} ($V_O < 0$)	
Continuous output current, IO	
Continuous current through V _{CC} or GND	±100 mA
Package thermal impedance, θ _{JA} (see Note 3): DB package	63°C/W
DGV package	86°C/W
DW package	46°C/W
NS package	65°C/W
PW package	88°C/W
Storage temperature range, T _{stq}	-65° C to 150° C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.
 - 2. The value of $V_{\hbox{\scriptsize CC}}$ is provided in the recommended operating conditions table.
 - 3. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 4)

			MIN	MAX	UNIT	
.,	Owner have the me	Operating	1.65	3.6		
VCC	Supply voltage	Data retention only	1.5		V	
		V _{CC} = 1.65 V to 1.95 V	0.65 × V _{CC}			
V_{IH}	High-level input voltage	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.7		V	
		V _{CC} = 2.7 V to 3.6 V	2			
		V _{CC} = 1.65 V to 1.95 V		0.35 × V _{CC}		
V_{IL}	Low-level input voltage	V _{CC} = 2.3 V to 2.7 V		0.7	V	
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$		0.8		
٧ _I	Input voltage		0	5.5	V	
	0	High or low state	0	VCC		
VO	VO Output voltage	3-state	0	5.5	V	
		V _{CC} = 1.65 V		-4		
	I Pale To a Landard Source of	V _{CC} = 2.3 V		-8	1 . 1	
ЮН	High-level output current	V _{CC} = 2.7 V		-12	mA	
		V _{CC} = 3 V		-24		
		V _{CC} = 1.65 V		4		
		V _{CC} = 2.3 V		8		
IOL	Low-level output current	V _{CC} = 2.7 V		12	mA	
		V _{CC} = 3 V		24	1	
Δt/Δν	Input transition rise or fall rate	•		10	ns/V	
TA	Operating free-air temperature		-40	85	°C	

NOTE 4: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CO	V _{CC}	MIN	TYP [†]	MAX	UNIT		
	I _{OH} = -100 μA		1.65 V to 3.6 V	V _{CC} -0.2				
	$I_{OH} = -4 \text{ mA}$		1.65 V	1.2				
	I _{OH} = -8 mA		2.3 V	1.7			V	
VOН	10 4		2.7 V	2.2			V	
	$I_{OH} = -12 \text{ mA}$		3 V	2.4				
	I _{OH} = -24 mA		3 V	2.2				
	I _{OL} = 100 μA		1.65 V to 3.6 V			0.2		
	I _{OL} = 4 mA	1.65 V			0.45			
VOL	I _{OL} = 8 mA	2.3 V			0.7	V		
	I _{OL} = 12 mA	2.7 V			0.4			
	I _{OL} = 24 mA		3 V			0.55		
II	V _I = 0 to 5.5 V		3.6 V			±5	μΑ	
loff	V_I or $V_O = 5.5 V$		0			±10	μΑ	
I _{OZ}	V _O = 0 to 5.5 V		3.6 V			±10	μΑ	
	$V_I = V_{CC}$ or GND	I _O = 0				10	_	
ICC	CC $3.6 \text{ V} \le \text{V}_{1} \le 5.5 \text{ V}^{\ddagger}$		3.6 V			10	μΑ	
ΔlCC	One input at V _{CC} – 0.6 V,	Other inputs at V _{CC} or GND	2.7 V to 3.6 V			500	μΑ	
Control inputs	V V OND		0.01/		5			
C _i Data inputs	$V_I = V_{CC}$ or GND		3.3 V		4		pF	
Co	$V_O = V_{CC}$ or GND		3.3 V		7		pF	

[†] All typical values are at $V_{CC} = 3.3 \text{ V}$, $T_A = 25^{\circ}\text{C}$. ‡ This applies in the disabled state only.

timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

		V _{CC} = 1.8 V ± 0.15 V		V _{CC} = 2.5 V ± 0.2 V		V _{CC} = 2.7 V		V _{CC} = 3.3 V ± 0.3 V		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
fclock	Clock frequency		§		§		150		150	MHz
t _W	Pulse duration, CLK high or low	§		§		3.3		3.3		ns
t _{su}	Setup time, data before CLK	§		§		1.9		1.9		ns
th	Hold time, data after CLK	§		§		1.5		1.5		ns

[§] This information was not available at the time of publication.



switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

PARAMETER FROM		METER FROM TO		$V_{CC} = 1.8 \text{ V} V_{CC} = 2.5 \text{ V} \pm 0.15 \text{ V} \pm 0.2 \text{ V}$		V _{CC} = 2.7 V		V _{CC} = 3.3 V ± 0.3 V		UNIT	
	(INPUT)	(OUTPUT)	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
f _{max}			†		†		150		150		MHz
^t pd	CLK	Q	†	†	†	†		8.5	2.2	7.3	ns
t _{en}	ŌĒ	Q	†	†	†	†		8.8	1.3	7.6	ns
^t dis	ŌĒ	Q	†	†	†	†		6.8	1.6	6.2	ns
t _{sk(o)}										1	ns

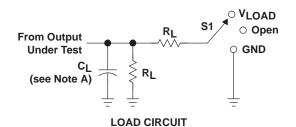
[†] This information was not available at the time of publication.

operating characteristics, $T_A = 25^{\circ}C$

	PARAMETER					V _{CC} = 3.3 V	UNIT	
			CONDITIONS	TYP	TYP	TYP		
C _{pd}	Power dissipation capacitance	Outputs enabled	f = 10 MHz	†	†	65	PΓ	
Фра	per flip-flop	Outputs disabled	1 = 10 MH2	†	†	48	рF	

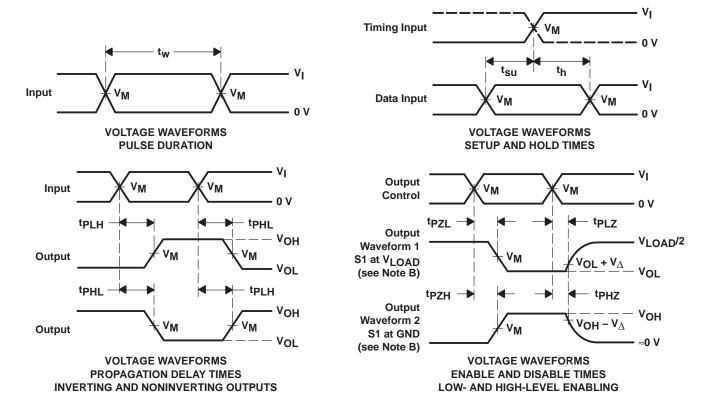
[†] This information was not available at the time of publication.

PARAMETER MEASUREMENT INFORMATION



TEST	S1
tPLH/tPHL	Open
tPLZ/tPZL	VLOAD
tPHZ/tPZH	GND

.,	INPUTS		.,		•	_	.,
VCC	٧ı	t _r /t _f	VM	VLOAD	CL	RL	$v_{\scriptscriptstyle\Delta}$
1.8 V \pm 0.15 V	VCC	≤2 ns	V _{CC} /2	2×V _{CC}	30 pF	1 k Ω	0.15 V
2.5 V \pm 0.2 V	VCC	≤2 ns	V _{CC} /2	2×VCC	30 pF	500 Ω	0.15 V
2.7 V	2.7 V	≤2.5 ns	1.5 V	6 V	50 pF	500 Ω	0.3 V
3.3 V \pm 0.3 V	2.7 V	≤2.5 ns	1.5 V	6 V	50 pF	500 Ω	0.3 V



- NOTES: A. C_I includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$.
 - D. The outputs are measured one at a time with one transition per measurement.
 - E. tpLz and tpHz are the same as tdis.
 - F. tpzI and tpzH are the same as ten.
 - G. tpLH and tpHL are the same as tpd.
 - H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms



DGV (R-PDSO-G**)

24 PINS SHOWN

PLASTIC SMALL-OUTLINE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.

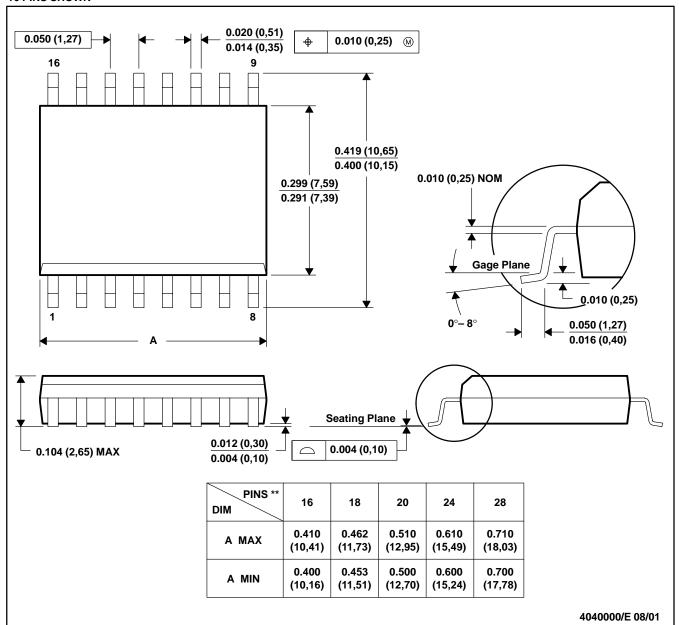
D. Falls within JEDEC: 24/48 Pins – MO-153 14/16/20/56 Pins – MO-194



DW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

16 PINS SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-013

MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



DB (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-150

PW (R-PDSO-G**)

14 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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